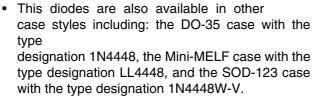


Small Signal Switching Diode

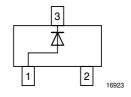
Features

- Silicon Epitaxial Planar Diodes
- Fast switching diode in case SOT-23, especially suited for automatic insertion.



- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC





Mechanical Data

Case: SOT-23 Plastic case Weight: approx. 8.8 mg Packaging Codes/Options:

GS18 / 10 k per 13" reel (8 mm tape), 10 k/box GS08 / 3 k per 7" reel (8 mm tape), 15 k/box

Parts Table

Part	Ordering code	Marking	Remarks
IMBD4448-V	IMBD4448-V-GS18 or IMBD4448-V-GS08	A3	Tape and Reel

Absolute Maximum Ratings

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage		V_{R}	75	V
Peak reverse voltage		V _{RM}	100	V
Rectified current (average) half wave rectification with resist.	T _{amb} = 25 °C and f ≥ 50 Hz	I _{F(AV)}	150 ¹⁾	mA
Surge forward current	$t < 1 \text{ s and } T_j = 25 ^{\circ}\text{C}$	I _{FSM}	500	mA
Power dissipation	T _{amb} = 25 °C	P _{tot}	350 ¹⁾	mW

¹⁾ Device on fiberglass substrate, see layout (SOT-23).

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Thermal Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air		R _{thJA}	450 ¹⁾	°C/W
Junction temperature		Tj	150	°C
Storage temperature range		T _S	- 65 to + 150	°C

¹⁾ Device on fiberglass substrate, see layout (SOT-23).

Electrical Characteristics

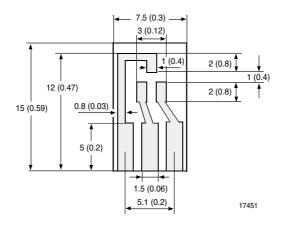
 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min	Тур.	Max	Unit
Forward voltage	I _F = 5 mA	V _F	0.62		0.72	V
	I _F = 100 mA	V _F			1.0	V
Leakage current	V _R = 70 V	I _R			2.5	μΑ
	$V_R = 70 \text{ V}, T_j = 150 ^{\circ}\text{C}$	I _R			50	μΑ
	$V_R = 25 \text{ V}, T_j = 150 ^{\circ}\text{C}$	I _R			30	μΑ
Diode capacitance	$V_F = V_R = 0$	C _{tot}			4	pF
Reverse recovery time (see figures)	$I_F = 10 \text{ mA}, I_R = 10 \text{ mA},$ $V_R = 6 \text{ V}, R_L = 100 \Omega$	t _{rr}			4	ns

Layout for R_{thJA} test

Thickness:

Fiberglass 1.5 mm (0.059 in.) Copper leads 0.3 mm (0.012 in.)





Typical Characteristics (Tamb = 25 °C unless otherwise specified)

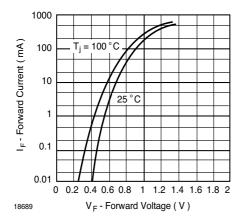


Figure 1. Forward Current vs. Forward Voltage

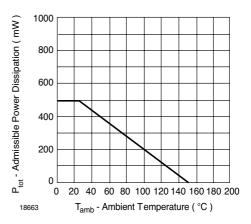


Figure 3. Admissible Power Dissipation vs. Ambient Temperature

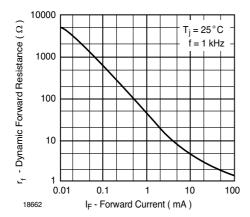


Figure 2. Dynamic Forward Resistance vs. Forward Current

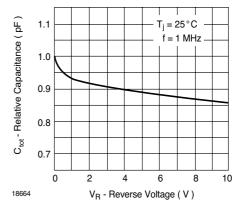


Figure 4. Relative Capacitance vs. Reverse Voltage

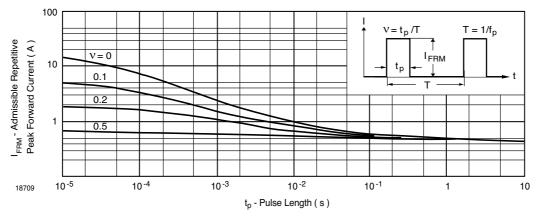
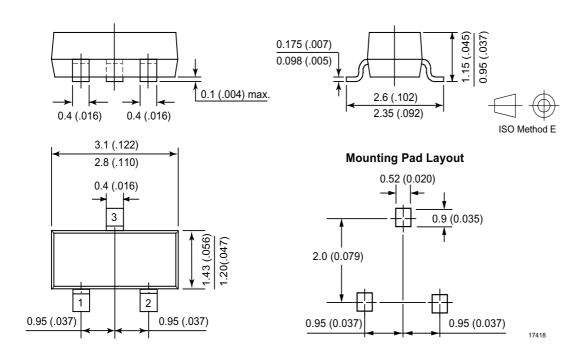


Figure 5. Admissible Repetitive Peak Forward Current vs. Pulse Duration

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Package Dimensions in mm (Inches)



5



Vishay Semiconductors

Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

> We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com